

### Product Summary

$V_{RRM}$	650 V
$I_F (T_c=155^\circ C)$	8 A
$Q_c$	24 nC

### Features

- Extremely low reverse current
- No reverse recovery current
- Temperature independent switching
- Positive temperature coefficient on  $V_F$
- Excellent surge current capability
- Low capacitive charge

### Benefits

- Essentially no switching losses
- System efficiency improvement over Si diodes
- Increased power density
- Enabling higher switching frequency
- Reduction of heat sink requirements
- System cost savings due to smaller magnetics
- Reduced EMI

### Applications

- Switch mode power supplies (SMPS)
- Uninterruptible power supplies
- Motor drivers
- Power factor correction

### Package Pin Definitions

- Pin1,3 and backside - Cathode
- Pin2 - Anode

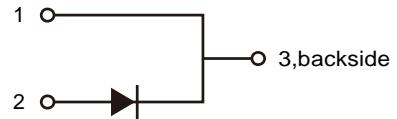
### Package Parameters

Part Number	Marking	Package
B1D08065E	B1D08065E	TO-252-2

### Package: TO-252-2



### Electrical Connection



**Maximum Ratings ( $T_c=25^\circ\text{C}$  unless otherwise specified)**

Symbol	Parameter	Test conditions	Value	Unit
$V_{\text{RRM}}$	Repetitive peak reverse voltage		650	V
$V_{\text{RSM}}$	Non-repetitive peak reverse voltage		650	V
$I_F$	Continuous forward current	$T_c=25^\circ\text{C}$ $T_c=155^\circ\text{C}$	27 8	A
$I_{\text{FSM}}$	Non-repetitive forward surge current	$T_c=25^\circ\text{C}, t_p=10\text{ms}$ Half sine wave	60	A
$\int i^2 dt$	i <sup>2</sup> t value	$T_c=25^\circ\text{C}, t_p=10\text{ms}$	18	A <sup>2</sup> S
$P_{\text{tot}}$	Power dissipation	$T_c=25^\circ\text{C}$ $T_c=110^\circ\text{C}$	109 47	W
$T_j$	Operating junction temperature		-55~175	°C
$T_{\text{stg}}$	Storage temperature		-55~175	°C

**Thermal Characteristics**

Symbol	Parameter	Value			Unit
		Min.	Typ.	Max.	
$R_{\text{th(jc)}}$	Thermal resistance from junction to case		1.365		K/W

**Electrical Characteristics**
**Static Characteristics**

Symbol	Parameter	Test conditions	Value			Unit
			Min.	Typ.	Max.	
$V_{DC}$	DC blocking voltage	$T_j=25^\circ C$	650			V
$V_F$	Diode forward voltage	$I_F=8A T_j=25^\circ C$ $I_F=8A T_j=175^\circ C$		1.43 1.75	1.60 2.85	V
$I_R$	Reverse current	$V_R=650V T_j=25^\circ C$ $V_R=650V T_j=175^\circ C$		1 10	70 100	$\mu A$

**AC Characteristics**

Symbol	Parameter	Test conditions	Value			Unit
			Min.	Typ.	Max.	
$Q_C$	Total capacitive charge	$V_R=400V T_j=25^\circ C$ $Q_C=\int_0^{V_R} C(V)dV$		24		nC
$C$	Total capacitance	$V_R=1V f=1MHz$ $V_R=300V f=1MHz$ $V_R=600V f=1MHz$		365 41.1 40.7		pF
$E_C$	Capacitance stored energy	$V_R=400V$		6		$\mu J$

### Typical Performance

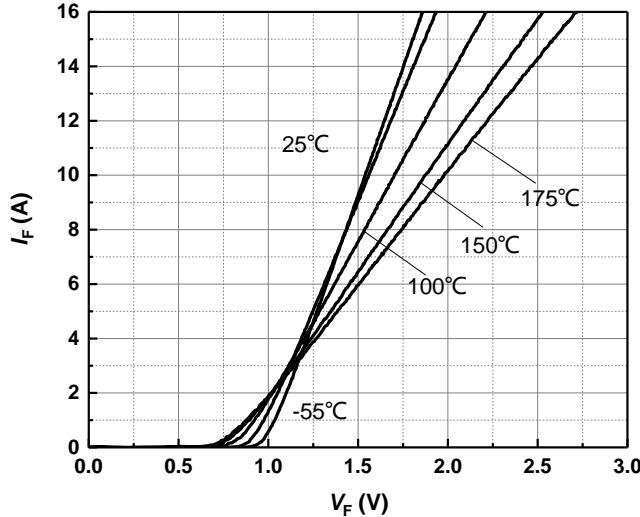


Figure 1 Typical forward characteristics

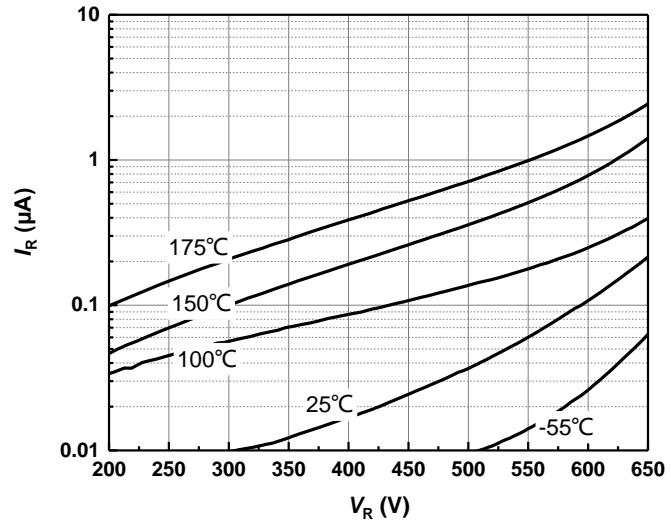


Figure 2 Typical reverse current as function of reverse voltage

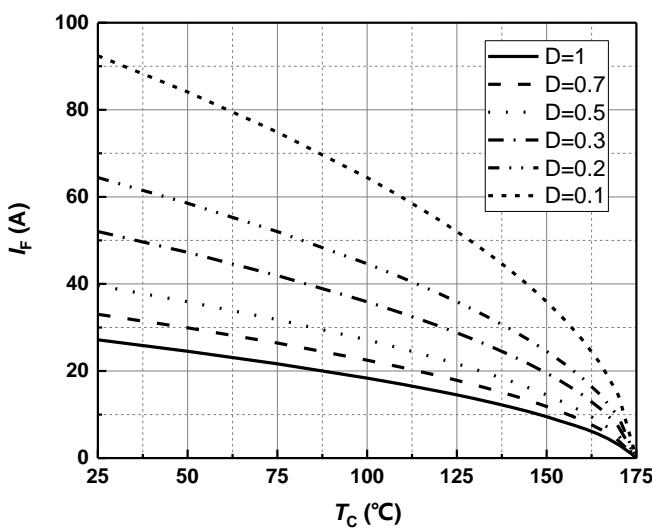


Figure 3 Diode forward current as function of temperature, D=duty cycle

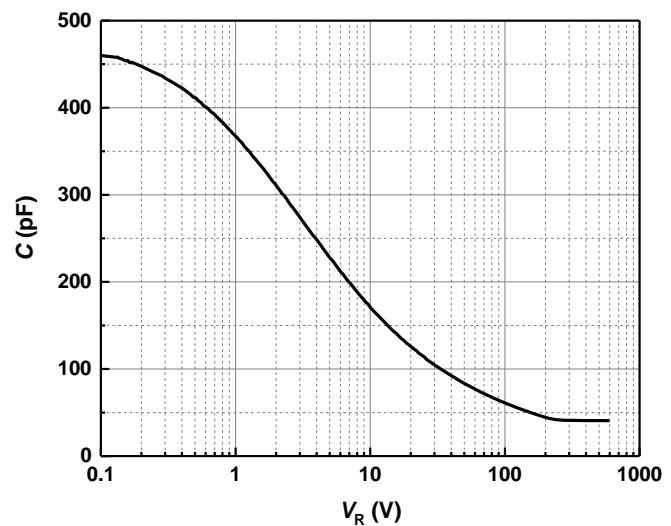


Figure 4 Typical capacitance as function of reverse voltage,  $C=f(V_R)$ ;  $T_j=25^\circ\text{C}$ ;  $f=1 \text{ MHz}$

### Typical Performance

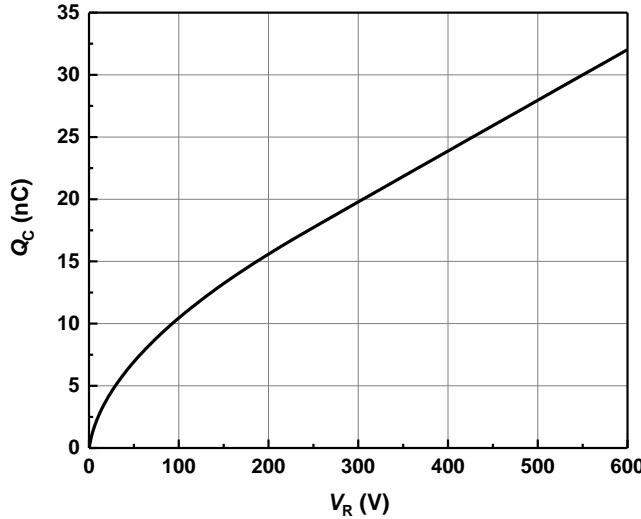


Figure 5    Typical reverse charge as function of reverse voltage

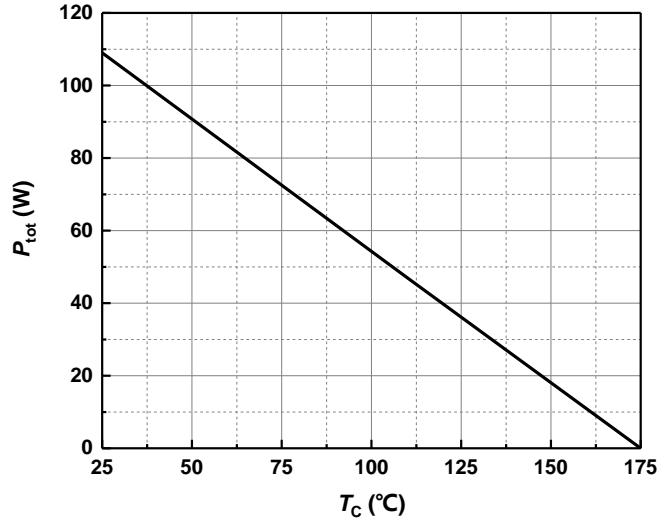


Figure 6    Power dissipation as function of case temperature

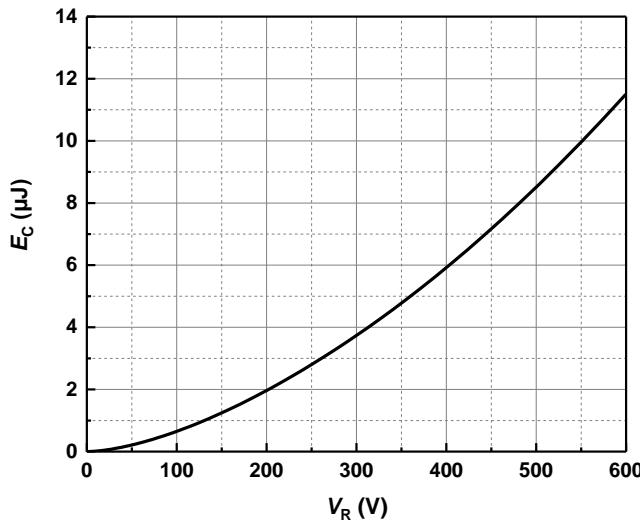


Figure 7    Capacitance stored energy

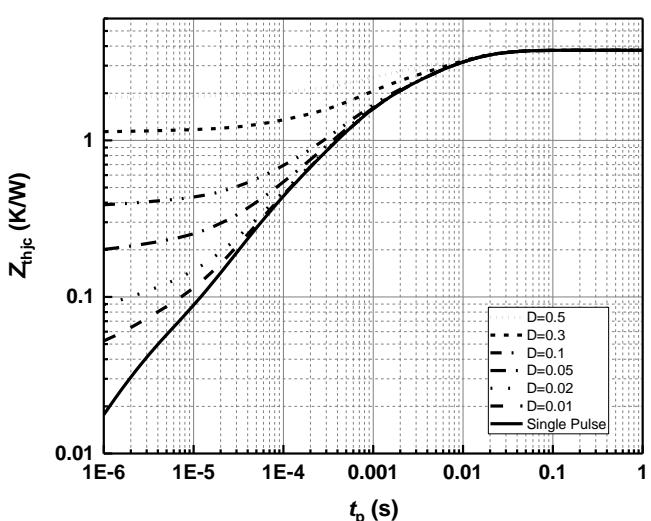
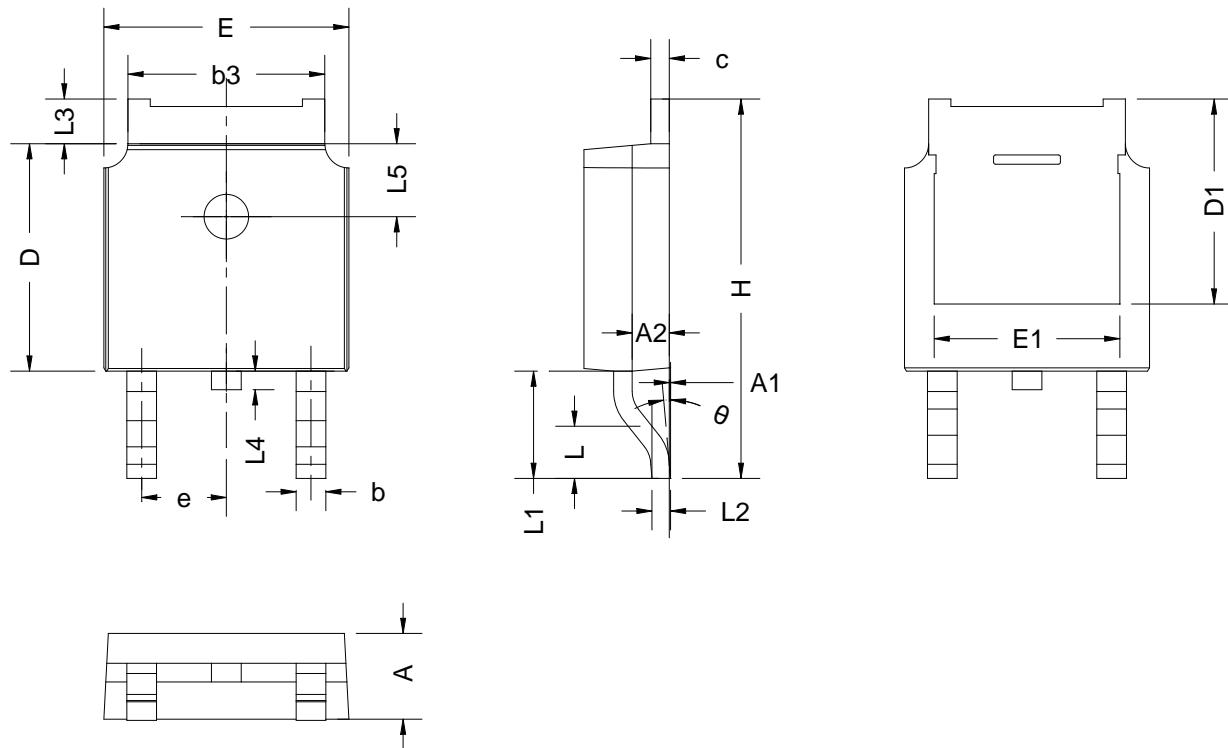


Figure 8    Max. transient thermal impedance,  $Z_{\text{thjc}} = f(t_p)$ , parameter:  $D = t_p / T$

**Package Dimensions**


SYMBOL	mm		
	MIN	NOM	MAX
A	2.20	2.30	2.38
A1	0.00	-	0.20
A2	0.90	1.07	1.17
b	0.68	0.78	0.90
b3	5.23	5.33	5.46
c	0.43	0.53	0.61
D	5.98	6.10	6.22
D1	5.30 REF		
E	6.40	6.60	6.73
E1	4.63	-	-
e	2.286 BSC		
H	9.40	10.10	10.50
L	1.38	1.50	1.75
L1	2.90 REF		
L2	0.51 BSC		
L3	0.88	-	1.28
L4	0.50	-	1.00
L5	1.65	1.80	1.95
θ	0°	-	8°

## Revision History

Document Version	Date of Release	Description of Changes
Rev. 1.0	2019-07-01	Release of the datasheet.
Rev. 2.0	2020-07-06	Characteristics updated.
Rev. 2.1	2022-06-07	Characteristics updated.
Rev. 2.2	2022-10-08	Characteristics updated.

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